

#### 3.0x2.5mm SURFACE MOUNT LED LAMP

Part Number: APB3025SURKCGKC-F01

Hyper Red Green

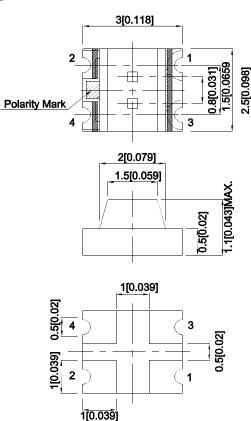
#### **Features**

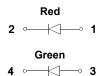
- 3.0mmx2.5mm SMD LED, 1.1mm thickness.
- Bi-color,Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

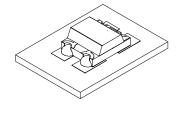
### **Descriptions**

- The Hyper Red source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.
- The Green source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.

# **Package Dimensions**









- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.2 (0.008")$  unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
   The device has a single mounting surface. The device must be mounted according to the specifications.

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### **Selection Guide**

	Part No.	Emitting Color (Material)	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
				Min.	Тур.	201/2
4	APB3025SURKCGKC-F01	Hyper Red (AlGaInP)	- Water Clear	120	250	120°
				*40	*70	
		Green (AlGalnP)		20	60	
				*20	*60	

- 1.  $\theta$ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- Luminous intensity/ luminous Flux: +/-15%.
   Luminous intensity value is traceable to CIE127-2007 standards.

## Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Emitting Color	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red Green	645 574		nm	I==20mA
λD [1]	Dominant Wavelength	Hyper Red Green	630 570		nm	I==20mA
Δλ1/2	Spectral Line Half-width	Hyper Red Green	28 20		nm	I==20mA
С	Capacitance	Hyper Red Green	35 15		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Hyper Red Green	1.95 2.1	2.5 2.5	V	IF=20mA
lR	Reverse Current	Hyper Red Green		10 10	uA	V <sub>R</sub> = 5V

#### Notes:

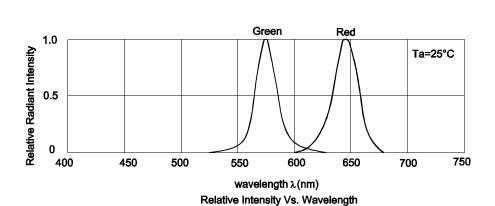
- 1.Wavelength: +/-1nm.
- 2.Forward Voltage: +/-0.1V.
- 3. Wavelength value is traceable to CIE127-2007 standards.
- 4.Excess driving current and/or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

### Absolute Maximum Ratings at TA=25°C

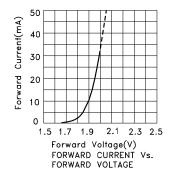
7 100 0 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1							
Parameter	Hyper Red	Green	Units				
Power dissipation	75	75	mW				
DC Forward Current	30 30		mA				
Peak Forward Current [1]	185	150	mA				
Reverse Voltage	5		V				
Operating Temperature	-40°C To +85°C						
Storage Temperature	-40°C To +85°C						

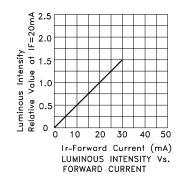
- 1. 1/10 Duty Cycle, 0.1ms Pulse Width.
- 1710 Duty Cycle, 0.111s Pulse Width.
   Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

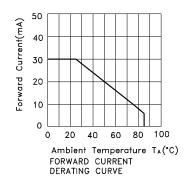
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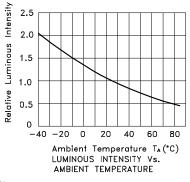


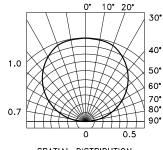
# APB3025SURKCGKC-F01 Hyper Red







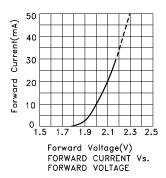


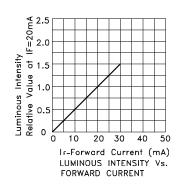


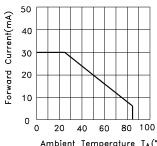
SPATIAL DISTRIBUTION

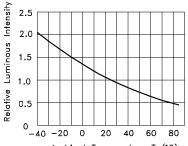
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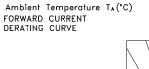
## Green



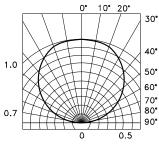












SPATIAL DISTRIBUTION

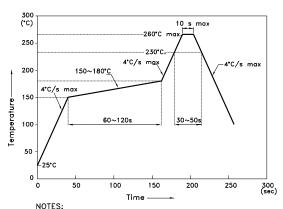
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#### APB3025SURKCGKC-F01

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



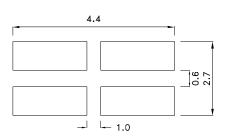
- NOTES:

  1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

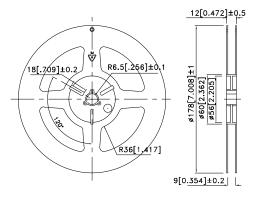
  2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

  3.Number of reflow process shall be 2 times or less.

# **Recommended Soldering Pattern** (Units: mm; Tolerance: ± 0.1)



# **Reel Dimension**



**Tape Dimensions** (Units: mm)

Ø1.5±0.1 4.0±0.1 1.75±0.1 0.229±0.1 2.0±0.1 4.0±0.1 1.27±0.1 3.5±0.1 3.35±0. Ø1.0Typ.

Tape

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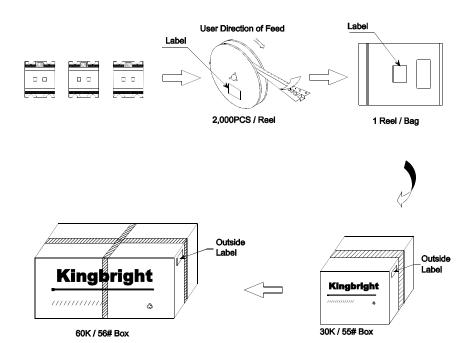
2.82±0.1 A-A SECTION

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#### **PACKING & LABEL SPECIFICATIONS**

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